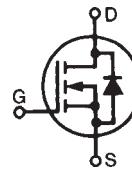
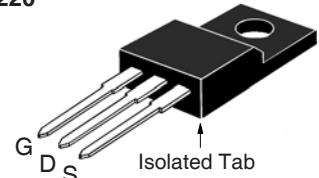


**X2-Class
Power MOSFET**
IXTP8N70X2M
(Electrically Isolated Tab)
N-Channel Enhancement Mode


V_{DSS} = 700V
 I_{D25} = 8A
 $R_{DS(on)}$ ≤ 550mΩ

**OVERMOLDED
TO-220**


G = Gate D = Drain
 S = Source

| Symbol | Test Conditions | Maximum Ratings | |
|---------------|--|-----------------|----------|
| V_{DSS} | $T_J = 25^\circ\text{C}$ to 150°C | 700 | V |
| V_{DGR} | $T_J = 25^\circ\text{C}$ to 150°C , $R_{GS} = 1\text{M}\Omega$ | 700 | V |
| V_{GSS} | Continuous | ±30 | V |
| V_{GSM} | Transient | ±40 | V |
| I_{D25} | $T_C = 25^\circ\text{C}$, Limited by T_{JM} | 8 | A |
| I_{DM} | $T_C = 25^\circ\text{C}$, Pulse Width Limited by T_{JM} | 16 | A |
| I_A | $T_C = 25^\circ\text{C}$ | 4 | A |
| E_{AS} | $T_C = 25^\circ\text{C}$ | 250 | mJ |
| dv/dt | $I_S \leq I_{DM}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$ | 50 | V/ns |
| P_D | $T_C = 25^\circ\text{C}$ | 32 | W |
| T_J | | -55 ... +150 | °C |
| T_{JM} | | 150 | °C |
| T_{stg} | | -55 ... +150 | °C |
| T_L | Maximum Lead Temperature for Soldering | 300 | °C |
| T_{SOLD} | 1.6 mm (0.062in.) from Case for 10s | 260 | °C |
| V_{ISOL} | 50/60 Hz, 1 Minute | 2500 | V~ |
| M_d | Mounting Torque | 1.13 / 10 | Nm/lb.in |
| Weight | | 2.5 | g |

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|--------------|---|-----------------------|------|---------------------------------------|
| | | Min. | Typ. | Max. |
| BV_{DSS} | $V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$ | 700 | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$ | 3.0 | | V |
| I_{GSS} | $V_{GS} = \pm 30\text{V}$, $V_{DS} = 0\text{V}$ | | | ± 100 nA |
| I_{DSS} | $V_{DS} = V_{DSS}$, $V_{GS} = 0\text{V}$ $T_J = 125^\circ\text{C}$ | | | 10 μA 250 μA |
| $R_{DS(on)}$ | $V_{GS} = 10\text{V}$, $I_D = 4\text{A}$, Note 1 | | | 550 mΩ |

Features

- International Standard Package
- Plastic Overmolded Tab
- High Voltage Package
- Low $R_{DS(ON)}$ and Q_G
- Avalanche Rated
- 2500V~ Electrical Isolation
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|-------------------------------------|---|-----------------------|------|---------------------------|
| | | Min. | Typ. | Max |
| g_{fs} | $V_{DS} = 10\text{V}$, $I_D = 4\text{A}$, Note 1 | 4.8 | 8.0 | S |
| R_{Gi} | Gate Input Resistance | | 6 | Ω |
| C_{iss} | $V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$ | 800 | | pF |
| C_{oss} | | 495 | | pF |
| C_{rss} | | 2.2 | | pF |
| Effective Output Capacitance | | | | |
| $C_{o(er)}$ | Energy related } $V_{GS} = 0\text{V}$ | 43 | | pF |
| $C_{o(tr)}$ | Time related } $V_{DS} = 0.8 \cdot V_{DSS}$ | 129 | | pF |
| $t_{d(on)}$ | $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 4\text{A}$ $R_G = 30\Omega$ (External) | 24 | | ns |
| t_r | | 28 | | ns |
| $t_{d(off)}$ | | 53 | | ns |
| t_f | | 24 | | ns |
| $Q_{g(on)}$ | $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 4\text{A}$ | 12.0 | | nc |
| Q_{gs} | | 3.1 | | nc |
| Q_{gd} | | 4.4 | | nc |
| R_{thJC} | | | 3.90 | $^\circ\text{C}/\text{W}$ |
| R_{thCS} | | 0.50 | | $^\circ\text{C}/\text{W}$ |

Source-Drain Diode

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified) | Characteristic Values | | |
|----------|---|-----------------------|------|---------------|
| | | Min. | Typ. | Max |
| I_s | $V_{GS} = 0\text{V}$ | | 8 | A |
| I_{sm} | Repetitive, pulse Width Limited by T_{JM} | | 32 | A |
| V_{SD} | $I_F = I_s$, $V_{GS} = 0\text{V}$, Note 1 | | 1.4 | V |
| t_{rr} | $I_F = 4\text{A}$, $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}$ | 200 | | ns |
| Q_{RM} | | 1.65 | | μC |
| I_{RM} | | 16.3 | | A |

Note 1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

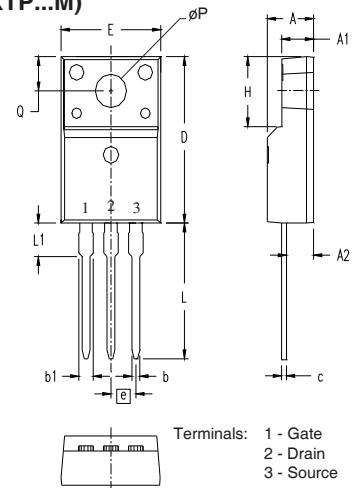
PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065B1 6,683,344 6,727,585 7,005,734B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123B1 6,534,343 6,710,405B2 6,759,692 7,063,975B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728B1 6,583,505 6,710,463 6,771,478B2 7,071,537

OVERMOLDED TO-220 (IXTP...M)



| SYM | INCHES | | MILLIMETERS | |
|-----|----------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .177 | .193 | 4.50 | 4.90 |
| A1 | .092 | .108 | 2.34 | 2.74 |
| A2 | .101 | .117 | 2.56 | 2.96 |
| b | .028 | .035 | 0.70 | 0.90 |
| b1 | .050 | .058 | 1.27 | 1.47 |
| c | .018 | .024 | 0.45 | 0.60 |
| D | .617 | .633 | 15.67 | 16.07 |
| E | .392 | .408 | 9.96 | 10.36 |
| e | .100 BSC | | 2.54 BSC | |
| H | .255 | .271 | 6.48 | 6.88 |
| L | .499 | .523 | 12.68 | 13.28 |
| L1 | .119 | .135 | 3.03 | 3.43 |
| ØP | .121 | .129 | 3.08 | 3.28 |
| Q | .126 | .134 | 3.20 | 3.40 |

Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

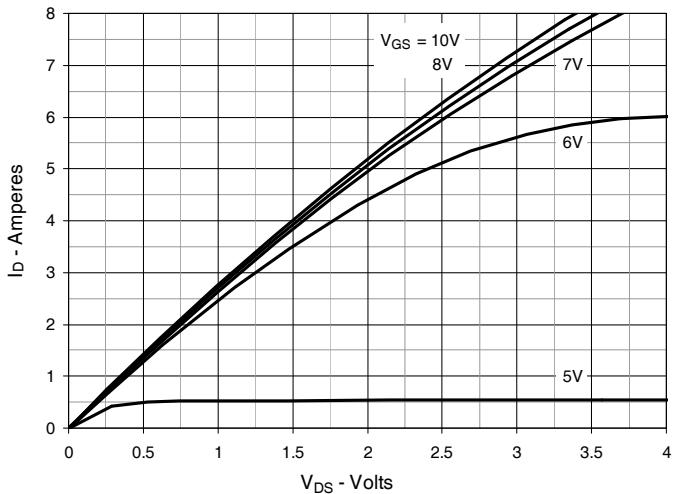


Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

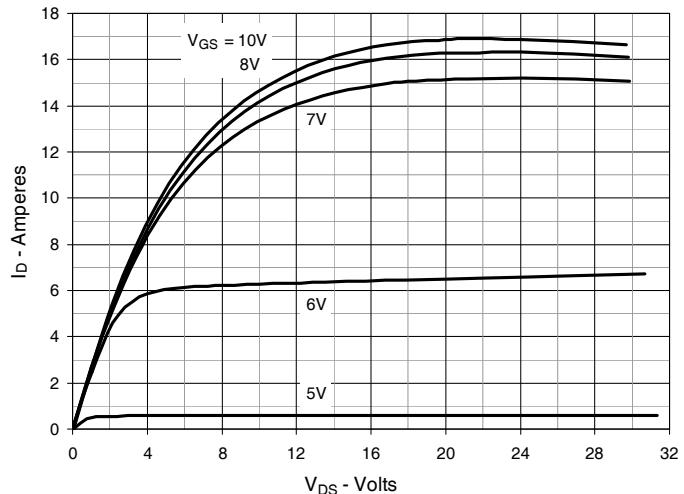


Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

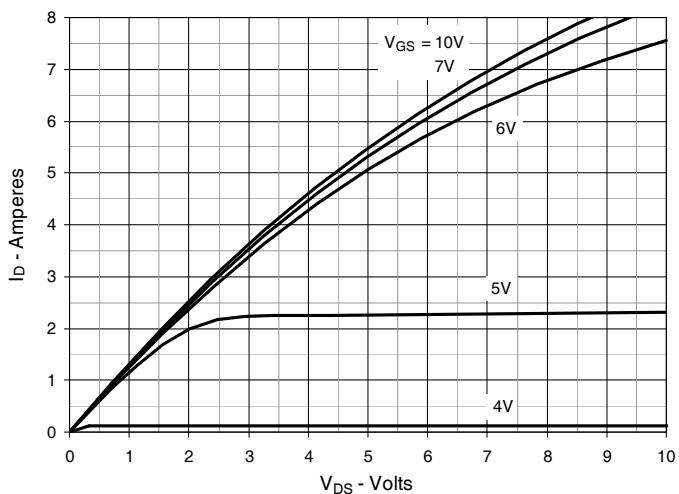


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 4\text{A}$ Value vs. Junction Temperature

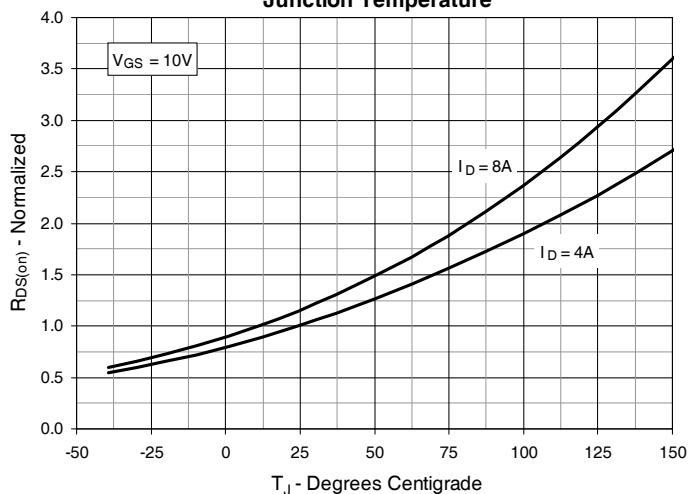


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 4\text{A}$ Value vs. Drain Current

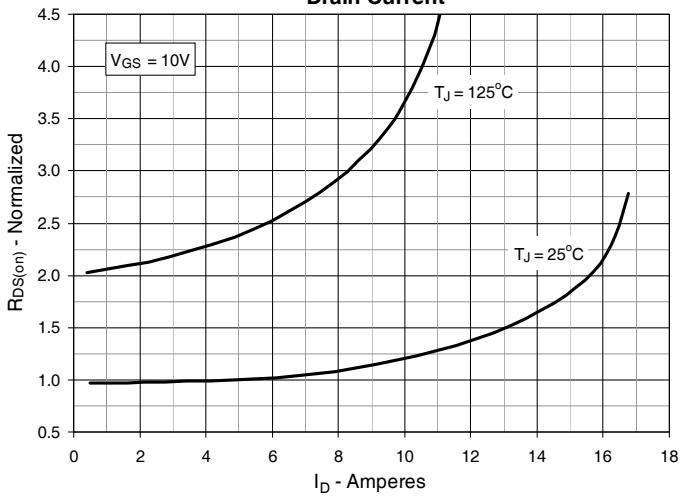


Fig. 6. Normalized Breakdown & Threshold Voltages vs. Junction Temperature

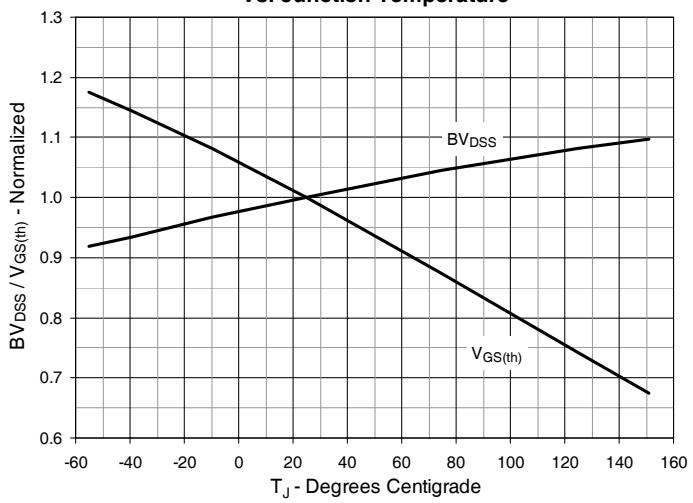


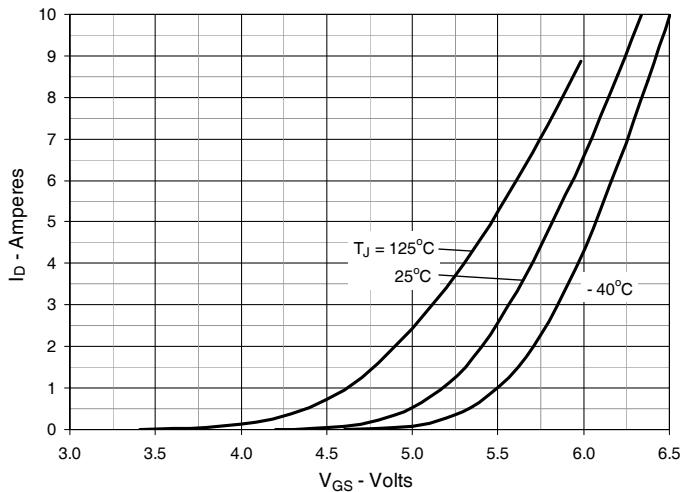
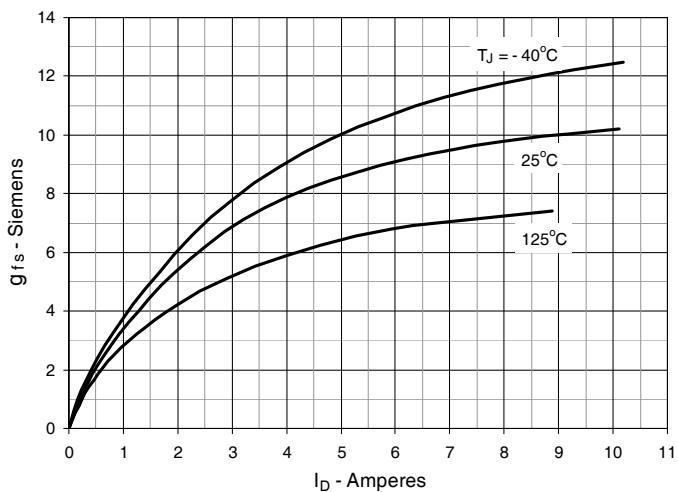
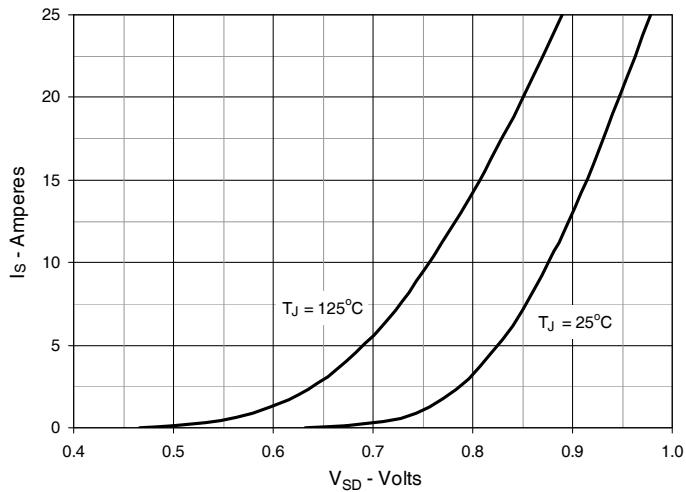
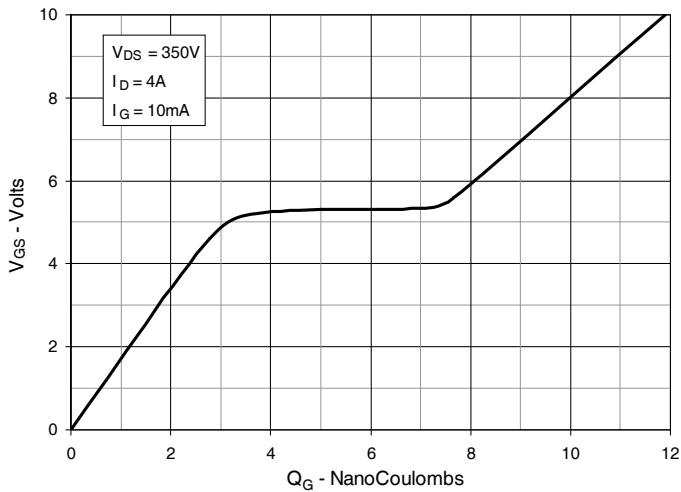
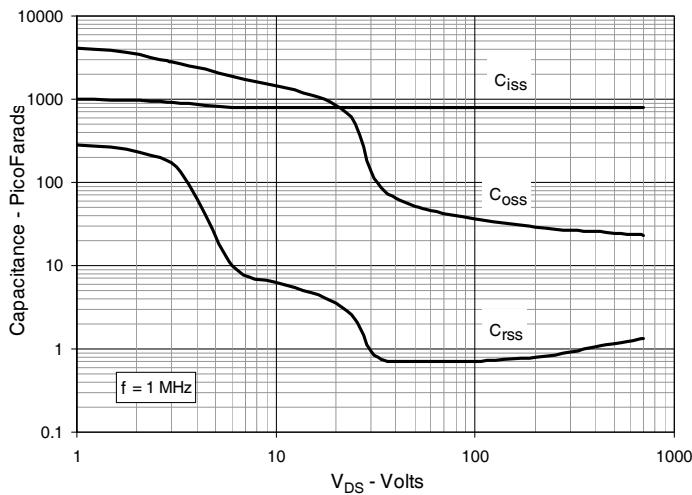
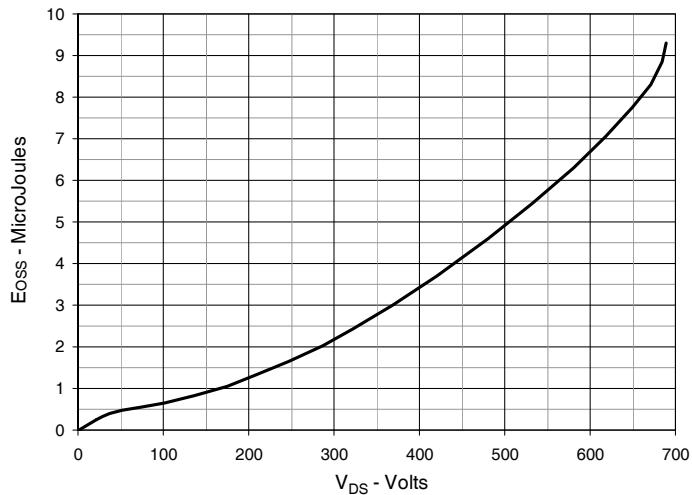
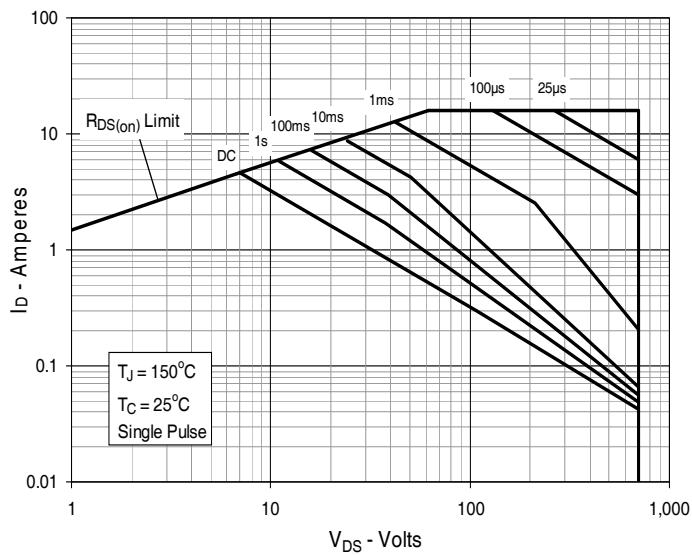
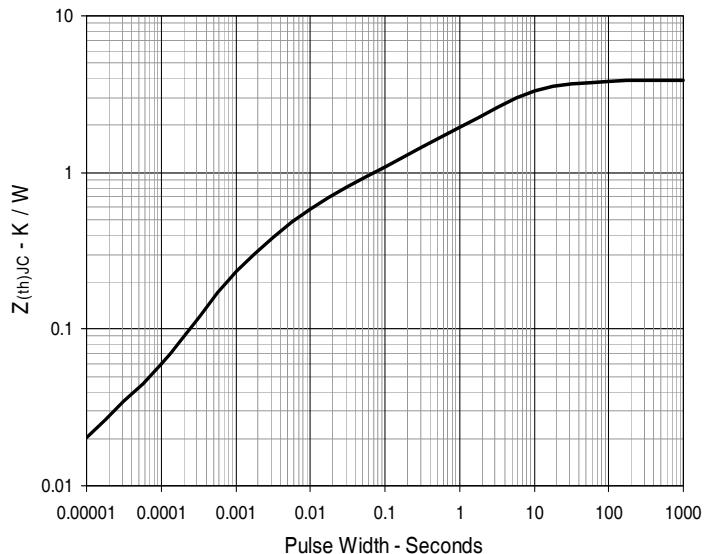
Fig. 7. Input Admittance**Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Output Capacitance Stored Energy**

Fig. 13. Forward-Bias Safe Operating Area**Fig. 14. Maximum Transient Thermal Impedance**

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